Behaviour of a tall vertical gas-evolving cell. Part I: Distribution of void fraction and of ohmic resistance

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Received 30 April 1990; revised 18 August 1990

Electrolysis of a 22 wt % NaOH solution has been carried out in a vertical tall rectangular cell with two segmented electrodes. The ohmic resistance of the solution between a segment pair has been determined as a function of a number of parameters, such as, current density and volumetric rate of liquid flow. It has been found that the ohmic resistance of the solution during the electrolysis increases almost linearly with increasing height in the cell. Moreover, a relation has been presented describing the voidage in the solution as a function of the distance from the electrodes and the height in the cell.

segments of the working and the counter

Notation

			electrode (Ω)
A_{e}	electrode surface area (m ²)	$R_{\rm p}$	resistance of bubble-free solution (Ω)
$a_{\rm s}$	parameter in Equation 12 (A^{-1})	$R_{n,20}^{r}$	$R_{\rm p}$ for segment pair 20 (Ω)
$b_{\rm s}$	parameter in Equation 12	$r_{\rm s}$	reduced specific surface resistivity
d	distance (m)	r_{s0}	r_s at $h = 0$
$d_{\rm ac}$	distance between the anode and the	$r_{s,20}$	r, for segment pair 20
	cathode (m)	$r_{s} \sim$	r, for uniform distribution of bubbles
$d_{ m wm}$	distance between the working electrode and	3, 00	between both the segments of a pair
	an imaginary separator (m)	$r_{s,\infty,20}$	$r_{s,\infty}$ for segment pair 20
F	Faraday constant ($C \mod^{-1}$)	$S_{\rm b}$	bubble-slip ratio
h	height from the leading edge of the working	$S_{\rm b, 20}$	$S_{\rm b}$ at segment pair 20
	electrode corresponding to height in the	$S_{\mathrm{b},h}$	$S_{\rm b}$ at height h in the cell
	cell (m)	T	temperature (K)
h _e	distance from the bottom to the top of the	$V_{\rm m}$	volume of 1 mol gas saturated with water
	working electrode (m)		vapor $(m^3 mol^{-1})$
$h_{\rm s}$	height of a segment of working	v_1	linear velocity of liquid $(m s^{-1})$
	electrode (m)	$v_{1,0}$	v_1 through interelectrode gap at the leading
Ι	current (A)	-,-	edges of both electrodes $(m s^{-1})$
I_{20}	current for segment pair 20 (A)	We	width of electrode (m)
I_{1-19}	total current for the segment pairs from	x	distance from the electrode surface (m)
	1 to 19 inclusive (A)	Ζ	impedance (Ω)
I_{x-19}	total current for the segment pairs from	Z'	real part of impedance (Ω)
	x to 19 inclusive (A)	Z''	imaginary part of impedance (Ω)
i	current density A m ⁻²	ρ	resistivity of solution (Ωm)
$N_{ m s}$	total number of gas-evolving pairs	$\rho_{\rm p}$	resistivity of bubble-free solution (Ωm)
n_1	constant parameter in Equation 8	β	gas volumetric flow ratio
n _a	number of electrons involved in the anodic	β_{20}	β at segment pair 20
	reaction	γ_{s}	specific surface resistivity (Ωm^2)
$n_{\rm c}$	number of electrons involved in the cathodic	$\gamma_{s,p}$	$\gamma_{\rm s}$ for bubble-free solution ($\Omega {\rm m}^2$)
	reaction	δ	thickness of Nernst bubble layer (m)
n _s	number of a pair of segments of the	δ_0	δ at $h = 0$ (m)
	segmented electrodes from their leading	3	voidage
	edges	$\mathcal{E}_{x,0}$	ε at x and $h = 0$
$Q_{ extsf{g}}$	volumetric rate of gas saturated with water	E _{0,0}	voidage at the leading edge of electrode
	vapour $(m^3 s^{-1})$		where $x = 0$ and $h = 0$
Q_1	volumetric rate of liquid $(m^3 s^{-1})$	$\mathcal{E}_{\infty,h}$	voidage in bulk of solution at height h
R	resistance of solution (Ω)	$\epsilon_{\infty,20}$	voidage in bubble of solution at the leading
R_{20}	resistance of solution between the top		edge of segment pair 20
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1. Introduction

Vertical electrolyzers with narrow inter-electrode gaps are used to produce gases such as chlorine, hydrogen and oxygen. Gas bubbles formed at one or both electrodes are present in the solution between the anode and the cathode. These non-conductive bubbles cause an increase in ohmic resistance and in ohmic potential drop over the solution. Moreover, bubbles attached to the electrode surface reduce the surface area of the electrode available for the electrode reaction and cause a rise in the local current density and of the overvoltage. It is well known that the bubble effect is significant at high-current densities in a narrow interelectrode gap. Insight into the distribution of void fraction and of current in the cell is of great interest in optimising the design of gas-evolving electrolysis cells.

Recently, Vogt [1] published an extensive review on current distribution in a vertical gas-evolving cell. To calculate the current distribution, knowledge of the voidage distribution over the sectional area of the inter-electrode gap and that in the vertical direction is necessary. Practically all theoretical calculations for the current distribution are based on the assumption of a uniform distribution of bubbles at each sectional area perpendicular to the flow direction of solution and bubbles. Vogt [2] and Sillen [3] introduced the concept of a bubble layer adjacent to the gas-evolving electrode, its thickness is equal to the average bubble diameter [3] or to the diameter of the largest attached bubble [2].

Bongenaar-Schlenter [4, 5] determined the degree of screening in the solution by bubbles as a function of the distance from a hydrogen-evolving electrode in a 6 mm gap between this electrode and a membrane. These experiments show that the bubble layer has a thickness, δ , being a factor of about 10 larger than the average bubble diameter. To calculate the ohmic resistance of the solution in the gap between the gas evolving electrode and the membrane a two-layer model was used [4, 5]. The effect of the void fraction in the bulk solution on the void fraction at the surface of the gas-evolving electrode was not taken into account [4, 5] and is completely unknown. Moreover, no results have been published about the thickness of the bubble layer at large void fractions of the bulk solution in a tall vertical cell with a very narrow inter-electrode gap.

Various models are proposed to describe the effect of the gas voidage in the bulk of solution on the gas voidage in the bubble layer adjacent to the electrode surface. The ohmic resistance of the solution is affected by the distribution of the gas voidage in the solution. To verify these models, ohmic-resistance experiments have been carried out.

2. Experimental details

2.1. Electrolysis cell and electrodes

The parallel-plate electrochemical cell and the

flow circuit have been described in [6]. The solution is pumped from a solution reservoir overflow-vessel upwards through the inter-electrode gap. Both electrodes were made from 1 mm thick nickel plate and were divided into 20 segments, each 0.010 m in width and 0.024 m in height, with a perspex-filled length of 1 mm between successive segments. The distance between the electrodes was 3.2 mm. This distance was adjusted by placing a 3 mm thick perspex frame with a hole of 0.010 m in width and of 0.80 m in length by sealing this frame with two Teflon sheets of 0.1 mm thickness. The cross-sectional area of the flow channel between the electrodes was 32 mm².

2.2. Electrical measurements

Current distribution. The potential difference between each pair of electrode segments was adjusted by a special constant-voltage source with 20 independent channels. Each segment was connected to the constantvoltage source by two contacts, one for the power supply and the other for the control of the potential. The potential range of the constant-voltage source was 0 to 50 V and the maximum current load for a pair of segments was 2.5 A.

The impedance measurements were carried out with a Solartron 1250 Frequency Responce Analyser and a Solartron Electrochemical Interface 1286, coupled with a HP microcomputer. The interface was used in the galvanostatic mode, where a controlled direct circuit was driven through an electrode-segment pair. The impedance of the part of the cell with this segment pair, was determined in the frequency range from about 3000 to 6000 Hz, unless otherwise stated. In this frequency range the imaginary part of impedance was zero. Usually, the impedance was determined for the top pair of electrode segments.

2.3. Void fraction

To determine the void fraction in the solution leaving the top of the cell, a glass valve with a curve inner tube of $7.72 \times 10^{-6} \text{ m}^3$ in volume was placed between the outlet of the cell and the solution reservoir. The length of the connection tube between the valve and the outlet of the cell was about 0.20 m and its inner diameter was 15 mm.

To measure the void fraction, the solution flow was stopped by turning the valve a half turn. Thereafter, within a fraction of a second, the electric current through the cell and the pump were switched off. After the solution in the tube between the valve and the overflow-vessel were free from rising bubbles, a gas burette was placed onto the inlet of the overflowvessel. The gas inside the inner tube of the valve flowed into the gas burette. The gas burette was thermostatted.

Because of the special construction of the valve, the gas present in the circuit solution below the valve did not flow into the gas burette.

2.4. Electrolysis conditions

The experiments were carried out with average current densities up to 6 kA m^{-2} using a 22 wt % NaOH solution at temperatures between 313 and 343 K, mostly, at 323 K. It has been found that at these temperatures the difference in temperature of the solution between the bottom and the top of the cell is negligible for the applied currents and solution flow rates. The volumetric rate of solution flow was varied, between 2×10^{-6} and $20 \times 10^{-6} \text{ m}^3 \text{ s}^{-1}$.

3. Results

3.1. Ohmic resistance of solution

3.1.1. Introduction. The alternating current impedance technique is widely used to determine the ohmic resistance of the solution of an electrochemical cell. This technique is well described in [7]. The impedance of the top part of the cell consisting of both the top segments and the solution in between was measured, whereas the other segments were connected to the constant voltage source. The direct current, I_{20} , for the top part of the cell was varied between 0.020 and 2.5 A. It was found that for the whole current range the Z'/Z'' curve intersects the Z' axis at a frequency of about 5000 Hz when the current through the other segments I_{1-19} was practically zero.

The ohmic resistance of the solution between the top segments, R_{20} , is equal to the impedance at Z'' = 0 in the high-frequency range from 4000 to 6000 Hz. A characteristic result for the dependence of R_{20} on I_{20} when I_{1-19} is practically zero is given in Fig. 1. From this curve it follows that R_{20} increases linearly with increasing I_{20} . The intersection of the R_{20}/I_{20} curve with the R_{20} axis gives $R_{p,20}$ being R_{20} in the absence of gas evolution.

From Fig. 1 it follows that $R_{\rm p,20} = 0.186 \Omega$. Using the relation $R_{\rm p} = \rho_{\rm p}/A_{\rm e}$ and introducing $d_{\rm ac} = 3.2 \times 10^{-3} \,\mathrm{m}$, $A_{\rm e} = 2.4 \times 10^{-4} \,\mathrm{m}^2$ and $\rho_{\rm p} = 1.506 \times 10^{-2} \,\Omega \,\mathrm{m}$ [8], it was calculated that $R_{\rm p,20} = 0.201 \,\Omega$. Taking into account the inaccuracy of the ratio $d_{\rm ac}/A_{\rm e}$ it can be concluded that the experimental and calculated $R_{\rm p,20}$ agree reasonably.

The current through each pair of segments was regulated by a unit of the constant-voltage source. This unit was used to switch off or on the current through the pair of segments connected to this unit. Unless otherwise stated, the segment pairs 1 to 19 inclusive were charged by the constant-voltage source and the segment pair 20 by the impedance meter.

It was found that the current I_{1-19} affects the minimum I_{20} where reliable results for R_{20} are still obtained. This minimum increases with increasing I_{1-19} and is equal to about 0.3 A for $I_{1-19} = 25$ A and 0.1 A for $I_{1-19} = 3$ A. The cell voltage for segment pair 20 during the measurement of impedance indicates the reliability of R_{20} . The cell voltage decreases strongly with decreasing I_{20} at high I_{1-19} . For instance, for $I_{1-19} = 25$ A the cell voltage for segment pair 20



Fig. 1. The ohmic resistance of the solution between the top segments of the segmented anode and cathode, R_{20} , as a function of the current through the top segments, I_{20} , at $I_{1-19} = 0$ A and $Q_1 = 6.0 \times 10^{-6} \,\mathrm{m^3 \, s^{-1}}$.

is -0.09, 1.73, 1.98 and 2.11 V for, respectively, $I_{20} = 0.1$, 0.2, 0.3 and 0.4 A. From the preceding it follows that reliable results for R_{20} can be obtained for I_{20} above a minimum I_{20} depending on I_{1-19} .

3.1.2. Effect of current and volumetric gas flow rate. The ohmic resistance of the solution for segment pair 20, R_{20} , was determined at various rates of gas evolution on segment pair 20 and on segment pairs located downwards.

In Fig. 2 the reduced resistance r_{20} , being $R_{20}/R_{p,20}$ is plotted as a function of I_{1-19} for various I_{20} . In this case all the segments located downwards were charged with a current $I_{s,av}$ being I_{1-19} divided by 19. Figure 2 shows that the r_{20}/I_{1-19} curves are practically straight and, moreover, almost parallel to one another. The



Fig. 2. The reduced ohmic resistance r_{20} as a function of the total current passed through the segment pairs from 1 to 19 inclusive, I_{1-19} , at various I_{20} and at $Q_1 = 6.0 \times 10^{-6} \,\mathrm{m^3 \, s^{-1}}$. I_{20} : (\triangle) 1 A; (\bigcirc) 0.8 A; (+) 0.4 A; (\bigtriangledown) 0.2 A.



Fig. 3. The reduced ohmic resistance r_{20} at $I_{20} = 0.4$ A and the total current passed through the gas-evolving segment pairs, I_{x-19} , as a function of the total number of gas-evolving segment pairs where the series of experiments starts with segment pair 19. The volumetric rate of liquid $Q_1 = 6.0 \times 10^{-6} \text{ m}^3 \text{ s}^{-1}$.

volumetric rate of the gas flow at the level of the lower edge of segment 20, $Q_{g,20}$, was also varied by decreasing of the number of current-passing pairs of segments.

At the start of the series of experiments all segments were switched on. The current was switched off for successive segment pairs, starting with the bottomsegment pair. During this series of experiments, the potential difference for the current-passing segment pairs was kept constant. In Fig. 3 I_{x-19} and r_{20} at $I_{20} = 0.4 \,\mathrm{A}$ are plotted against the total number of gas-evolving segment pairs, N_s . From this figure it follows that up to about $N_s = 10$, I_{x-19} as well as r_{20} increases linearly with increasing $N_{\rm s}$, and so with increasing height in the cell. Comparing Figs. 2 and 3 it follows that r_{20} at $I_{20} = 0.4$ A increases linearly with the total current used for gas evolution on segment pairs located downwards and does not depend on the current distribution over the downwards located segment pairs.

For the series of experiments for which results are given in Fig. 2, the reduced resistance r_{20} is given in Fig. 4 as a function of I_{20} . In this I_{20} range r_{20} inclines very sharply with decreasing I_{20} . To obtain reliable results the ratio of I_{20} to the current through the segment pairs next to segment pair 20 has to be sufficiently large (see §3.1). Fig. 4 shows that the slope of the r_{20}/I_{20} curve decreases with increasing I_{1-19} . Moreover, the r_{20}/I_{20} line at low I_{20} may be slightly bent for high I_{1-19} .

To get insight into the distribution of bubbles between the top segments, gas bubbles were evolved at a group of only 4 successive segment pairs located downwards where the other segments were swtiched off. r_{20} was determined for various distances between the top edge of this group of gas-evolving pairs and the lower edge of the top-segment pair. The measurements were carried out for both decreasing and



Fig. 4. The reduced ohmic resistance r_{20} as a function of I_{20} for various total current passed through the segment pairs from 1 to 19 inclusive, I_{1-19} , and at $Q_1 = 6.0 \times 10^{-6} \text{ m}^3 \text{ s}^{-1}$. I_{1-19} : (+) 0 A; (\diamond) 3 A; (\diamond) 5 A; (\bigcirc) 10 A; (\bigtriangledown) 15 A; (\square) 20 A; (\blacklozenge) 25 A; (\blacktriangle) 30 A.

increasing distance between the group of gas-evolving pairs and the top-segment pair. It was found that the reduced resistance r_{20} at $I_{20} = 0.4$ A does not depend on the distance between segment pair 20 and the group of gas-evolving pairs on which gas was evolved. From this result it is concluded that the bubbles formed at lower sites are uniformly distributed over the higher cross-section of the cell.

The reduced resistance r_{20} was also determined for three series of experiments with a constant total rate of gas evolution on an increasing number of segment pairs. The total current was adjusted to 2.0, 1.5 and 1.0 A and the gas-evolving segment pairs were, successively, 19, 18–19, 17–19, 16–19, 15–19 and 14–19. This means that the current density on a gasevolving segment decreased with increasing number of gas-evolving segments. The reduced resistance R_{20} at I_{20} from 0.4 to 0.8 A was practically independent of the number of gas-evolving segment pairs. This result also indicates that the distribution of bubbles formed at lower sites is practically uniform over a cross-section of the cell.

3.1.3. Effect of volumetric liquid flow rate. The effect of the volumetric rate of liquid flow was investigated by performing a series of experiments at various Q_1 . For a series of experiments r_{20} at various I_{20} was determined for decreasing I_{1-19} . Figure 5 shows r_{20} at $I_{20} = 0.4$ A as a function of the inverse of the volumetric rate of liquid flow, Q_1^{-1} , at various I_{1-19} . Moreover at low Q_1 , viz. 3.0×10^{-6} m³ s⁻¹ it was found that r_{20} reaches a maximum at $I_{1-19} = 20$ A and thereafter r_{20} declines with increasing I_{1-19} . The maximum r_{20} is reached at a gas volumetric flow ratio, β , of about 0.60. The gas-vapour volumetric flow ratio, β , is defined as $Q_g/(Q_g + Q_1)$, where Q_g is the volumetric rate of gas saturated with water vapour. From Fig. 5 it follows that for $Q_1 > 6.0 \times 10^{-6}$ m s⁻¹, r_{20} at



Fig. 5. The reduced ohmic resistance r_{20} at $I_{20} = 0.4$ A as a function of the inverse of the volumetric rate of liquid, Q_1^{-1} , at various I_{1-19} .

 $I_{20} = 0.4 \,\mathrm{A}$ is proportional to $Q_1^{-0.50}$. The same proportionality between r_{20} and Q_1 was also found for the other values of I_{20} .

3.3. Relation between the reduced resistance of solution and void fraction

Both the reduced resistance of the solution between the top segments at various I_{20} and the void fraction of the solution in the valve between the top of the cell and the overflow-vessel were determined during the same experiment at $I_{1-19} = 25$ A and $Q_1 = 18.0 \times 10^{-6}$ m³ s⁻¹ corresponding to $v_{1,0} = 0.56$ m s⁻¹. Assuming 100% current efficiencies for both H₂ and O₂ evolution, and neglecting the dissolution of both gases it can be calculated that the volumetric rate of formation of gas saturated with water vapour is 5.662 cm³ s⁻¹ at 323 K and a pressure of 1 atmosphere. It can be calculated that at $I_{20} = 0$ the factor $\beta_{20} = 0.239$ at a pressure of 1 atmosphere.

From five measurements it was found that the void fraction of the solution present in the valve would be $\varepsilon_v = 0.234 \pm 0.005$ at a pressure of 1 atmosphere.

Using the Bruggeman equation, viz. $r = (1 - \varepsilon)^{-3/2}$, it can be calculated that $\varepsilon_{20} = 0.212 \pm 0.004$ and would be 0.23 at a pressure of 1 atmosphere. The reduced resistance at $I_{20} = 0$ A is equal to 1.43 ± 0.01 . This value was obtained by extrapolation of the r_{20}/I_{20} curve to $I_{20} = 0$ A for the experiments with $v_{1,0} = 0.56 \,\mathrm{m \, s^{-1}}$.

4. Theory

To simplify the treatment of the increase in the ohmic resistance of the cell due to the presence of gas bubbles, a half-cell with a rectangular configuration is discussed. Such a simple geometry was also studied by Tobias [9] and Vogt [2].

The half-cell is a rectangular cell compartment of

which one wall is formed by a gas-evolving flat-plate electrode and the opposite one by a real or an imaginary flat-plate separator. The following assumptions are made:

- The height h_e and the width w_e of the electrode and the separator are much larger than the distance between electrode and separator.
- The electrode is perfectly electrically conductive; its potential and that of the separator are constant.
- The flow of current in the cell is unidirectional, the current flows only through the electrode and the separator, the other walls of the half-cell are electrically insulated.
- The velocity profile of the liquid in the half-cell corresponds to plug flow, its volumetric flow rate is constant.
- The temperature is constant in the whole half-cell.
- The gas voidage in the bulk of solution at the bottom $(h \ 0)$ is zero and at the top is ε_t .

The most recent model was presented by Bongenaar-Schlenter [4, 5]. She introduced a bubble layer adjacent to the surface of the gas-evolving electrode. The thickness of the bubble layer at h = 0 is indicated by δ_0 and the voidage at x = 0 and h = 0 by $\varepsilon_{0,0}$.

The voidage in the bubble layer at the bottom of the cell $(x < \delta_0)$ is given by

$$\varepsilon_{x,0} = \varepsilon_{0,0} - \frac{\varepsilon_{0,0}x}{\delta_0} \tag{1}$$

A bubble-liquid mixture can be considered as a random dispersion of spherical insulators with a large size-range of spheres; the Bruggeman equation is used to calculate its ohmic resistance [10]. The Bruggeman equation is

$$R = R_{\rm p}(1-\varepsilon)^{-3/2} \tag{2}$$

where R is this ohmic resistance of the bubblecontaining solution of a voidage, ε , and R_p is the ohmic resistance of the bubble-free solution.

The specific surface resistivity of the bubble-free bulk solution, i.e. between $x = \delta_0$ and $x = d_{wm}$, at the bottom of the cell is given by

$$\gamma_{\rm s,1} = \rho_{\rm p}(d_{\rm wm} - \delta_0) \tag{3}$$

and that of the bubble layer, i.e. between x = 0 and $x = \delta_0$, at the bottom of the cell is given by

$$\gamma_{s,2} = \rho_p \int_0^{\delta_0} (1 - \varepsilon_{x,0})^{-1.5} dx$$
 (4)

Summing these two specific surface resistivities gives the specific surface resistivity of the solution between the electrode and the separator at h = 0; so

$$\gamma_{\rm s} = \gamma_{\rm s,1} + \gamma_{\rm s,2} \tag{5}$$

The resistivity of the bubble-free solution between the working electrode and the separator does not depend on the height in the cell compartment; so the specific surface resistivity is given by

$$\gamma_{\rm s,p} = \rho_{\rm p} d_{\rm wm} \tag{6}$$



Fig. 6. The voidage at the electrode surface, $\varepsilon_{0,0}$ as a function of thicknesses of Nernst bubble layer for the bottom level in the half-cell where h = 0 at various reduced specific surface resistance. The distance between the electrode and the separator, $d_{\rm wm}$, is 1.6 mm.

where d_{wm} is the distance between the working electrode and the separator.

The reduced specific surface resistivity is defined by $r_s = \gamma_s / \gamma_{s,p}$. From this definition and Equations 3–6 it follows that the reduced specific surface resistivity at the bottom of the half-cell, i.e. at h = 0 is given by

$$r_{s,0} = \frac{1}{d_{wm}} \int_0^{\delta_0} (1 - \varepsilon_{x,0})^{-1.5} \, \mathrm{d}x + \left(\frac{d_{wm} - \delta_0}{d_{wm}}\right) \quad (7)$$

where $\varepsilon_{x,0}$ is given by Equation 1. $r_{s,0}$ was numerically calculated for various δ_0 , $\varepsilon_{0,0}$ and d_{wm} . Figure 6 shows $\varepsilon_{0,0}/\delta_0$ curves at various $r_{s,0}$.

The effect of the void fraction in the bulk of solution on the void fraction at the electrode surface has not yet been discussed in the literature. Moreover, at a constant volumetric flow rate of liquid the void fraction in the bulk of solution also affects the liquid velocity.

To elucidate the effect of void fraction in the bulk solution, the specific surface resistivity of the solution between the gas-evolving electrode and the imaginary separator was calculated for different models describing the effect of the voidage in the bulk of solution on the thickness of bubble layer and the voidage at the gas-evolving electrode [11].

These models can be replaced by a general model where the voidage in the bubble layer with a thickness δ_0 , that is at $0 < x < \delta_0$, is given by

$$\varepsilon_{x,h}^{n_1} = \varepsilon_{0,0}^{n_1} \left(1 - \frac{x}{\delta_0}\right)^{n_1} + \varepsilon_{\infty,h}^{n_1}$$
(8)

and the voidage in the bulk solution layer, that is at $\delta_0 < x < d_{wm}$, is given by

$$\varepsilon_{x,h} = \varepsilon_{\infty,h} \tag{9}$$

It can be shown that the reduced specific surface



Fig. 7. $r/r_{s,\infty}$ is plotted versus $\varepsilon_{\infty,h}$ for $r_{s,0} = 1.215$, $d_{wm} = 1.6 \text{ mm}$, $n_1 = 4$ and various $\varepsilon_{0,0}$.

resistivity at various $\varepsilon_{\infty,h}$ is given by

$$r_{\rm s} = \frac{1}{d_{\rm wm}} \int_{0}^{\delta_0} (1 - \varepsilon_{{\rm x},h})^{-1.5} \,\mathrm{d}x + (1 - \varepsilon_{{\rm x},h})^{-1.5} \frac{(d_{\rm wm} - \delta_0)}{d_{\rm wm}} \qquad (10)$$

where $\varepsilon_{x,h}$ is given by Equation 8.

Czarnetzki [11] has calculated the reduced specific surface resistivity for various models as a function of $\varepsilon_{0,0}$ and $\varepsilon_{\infty,h}$. The model where the void fraction at the gas-evolving electrode is independent of the void fraction in the bulk of solution is practically equal to the general model with $n_1 \rightarrow \infty$. It has been found that for this model the $r_s/\varepsilon_{\infty,h}$ curves at various $\varepsilon_{0,0}$ converge with increasing $\varepsilon_{\infty,h}$. For the general model with $n_1 = 1$ the $r_s/\varepsilon_{\infty,h}$ curves at various $\varepsilon_{0,0}$ diverge clearly with increasing $\varepsilon_{\infty,h}$ [11], for the one with $n_1 = 2$ the curves are practically parallel to one



Fig. 8. $r/r_{s,\infty}$ is plotted against $\varepsilon_{\infty,h}$ for $r_{s,0} = 1.215$, $\varepsilon_{0,0} = 0.5 d_{wm} = 1.6 \text{ mm}$ and various n_1 .

another [11] and for the one with $n_1 = 3$ the curves converge slightly (unpublished work).

To demonstrate more clearly the most useful model, for various models $r_s/r_{s,\infty}$ has been calculated as a function of $\varepsilon_{\infty,h}$ at $d_{wm} = 1.6$ mm, and at various combinations of δ_0 and $\varepsilon_{0,0}$ where 0.1 mm $< \delta_0 < 1.6$ mm. For $n_1 = 4 r_s/r_{s,\infty}$ is plotted versus $\varepsilon_{\infty,h}$ in Fig. 7 for $r_{s,0} = 1.215$, $d_{wm} = 1.6$ mm and various $\varepsilon_{0,0}$. The parameter δ_0 has been calculated using Equation 7. From Fig. 7 it follows that the decrease in $r_s/r_{s,\infty}$ with increasing $\varepsilon_{\infty,h}$ depends strongly on $\varepsilon_{0,0}$.

The effect of n_1 on the relation between $r_s/r_{s,\infty}$ and $\varepsilon_{\infty,h}$ is shown in Fig. 8 for $r_{s,0} = 1.215$ and $\varepsilon_{0,0} = 0.5$. From this figure it follows that the decline in $r_s/r_{s,\infty}$ with increasing $\varepsilon_{\infty,h}$ is more sharp with increasing n_1 .

5. Discussion

5.1. Horizontal distribution of void fraction

During the electrolysis of a NaOH solution hydrogen and oxygen bubbles are formed at, respectively, the nickel cathode and anode. The void fraction decreases with increasing distance from the gas-evolving electrode. Bongenaar-Schlenter [4, 5] introduced the concept of a bubble layer adjacent to the gas-evolving electrode. The thickness of this first-bubble layer, δ , depends on various parameters.

For a first approach it is reasonable to propose that the differences in $\varepsilon_{0,0}$ and δ_0 for the oxygen- and the hydrogen-evolving electrode are neglected. This means that the undivided water electrolyzer with an interelectrode gap of 3.2 mm is considered as two half-cells with the distance between an electrode and an imaginary separator being 1.6 mm. Based on the experimental results with transparent nickel electrodes at low void fractions in the bulk of solution [12] and assuming the degree of screening of the electrode by bubbles is equal to the void fraction in the solution at the electrode surface, it can be concluded that the void fraction $\varepsilon_{0,0}$ at the leading edge of both the hydrogenand oxygen-evolving nickel electrode in 22 wt % NaOH at 323 K, 2 kA m⁻² and $v_{1,0} = 0.2 \text{ m s}^{-1}$ is equal to about 0.3.

The reduced resistance for segment pair 20 in the absence of gas evolution on the other segments can be obtained from Fig. 1 and is equal to 1.103 at $i = 2 \text{ kA m}^{-2}$. If the effect of the small height of segment pair 20, *viz.* 24 mm, on the reduced specific surface resistivity r_s is neglected, then r_{20} at $I_{1-19} = 0$ A is $r_{s,0}$. Using Equation 7 for $r_{s,0}$ and Equation 1 for $\varepsilon_{x,0}$ it can be calculated that $\delta_0 = 0.55 \text{ mm}$ at $\varepsilon_{0,0} = 0.3$.

Bongenaar-Schlenter [4] has determined the thickness of the bubble layer at a hydrogen-evolving electrode in 1 M KOH at 303 K and various current densities, liquid-flow rates and distances from the leading edge of the electrode. Using her experimental correlation it has been found that $\delta_0 = 0.22 \text{ mm}$ at 2 kA m^{-2} , $v_{1,0} = 0.188 \text{ ms}^{-1}$ and at a distance of 12 mm from the leading edge of the electrode. The two values for δ_0 are of the same order of magnitude.

5.2. Vertical distribution of void fraction

From the impedance measurements it follows that the distribution of bubbles formed at the lower parts of the electrode is practically uniform over the bulk of solution (§3.1.2). The bubbles evolved on the electrode at a cross-section of the cell join the bubbles formed at lower cross-sections of the cell. The compartment between anode and cathode is divided into two equal anodic and cathodic bubble layers and a layer of bulk solution.

From resistance measurements, and using the Bruggeman equation, it has been found that, in the absence of gas evolution on the top segments, the void fraction in the solution between the top segments agrees reasonably with the void fraction in the valve and with the factor β_{20} at $I_{20} = 0$ A and a pressure of 1 atmosphere. This factor is equal to the void fraction when the bubble-slip ratio $S_b = 1$ and the supersaturation of solution by the gases formed is negligible (§3.3). The experiments of (§3.3) were carried out at a relatively high solution velocity, namely $v_{1,0} = 0.56 \text{ m s}^{-1}$.

The natural rise velocity of a single electrolysis bubble is in the order of $0.002 \,\mathrm{m \, s^{-1}}$ [13]. Consequently, the effect of bubble slip at $v_{1,0} = 0.56 \,\mathrm{m \, s^{-1}}$ can be neglected. Moreover, from the preceding discussion it follows that between the top segments and under the conditions of the experiments of (§3.3) the supersaturation of solution can be neglected.

Figure 4 shows r_{20}/I_{20} curves at various I_{1-19} for a relatively low liquid flow rate, namely $v_{1,0} = 0.188 \text{ m s}^{-1}$. Extrapolation of the r_{20}/I_{20} curve gives r_{20} at $I_{20} = 0$ A. This parameter is plotted against I_{1-19} in Fig. 9. Using the Bruggeman relation the void fraction $\varepsilon_{\infty,20}$ has been calculated. This void fraction has been plotted as a function of I_{1-19} in Fig. 9. The gas volumetric flow ratio, β_{20} , in the cell at the leading edge of the top segment pair has been calculated and is also plotted in Fig. 9, where it has been taken into account that the pressure is about 8% higher than the atmospheric pressure and the gas evolved is saturated with water vapour.

From Fig. 9 it follows that the resistivity r_{20} at $I_{20} = 0$ A increases linearly with increasing I_{1-19} and that the void fraction $\varepsilon_{\infty,20}$ at $I_{20} = 0$ is clearly smaller than the gas volumetric flow ratio β_{20} . Since the supersaturation of the solution between the top segments is negligible, the difference between $\varepsilon_{\infty,20}$ and β_{20} is caused by a higher bubble velocity than the linear velocity of liquid.

From the relations for the bubble-slip ratio, *viz*. $S_{\rm b} = v_{\rm g}/v_1$, the void fraction ε and the gas volumetric flow ratio β [14] it can be deduced that

$$S_{\rm b} = \frac{Q_{\rm g}^{(1-\varepsilon)}}{Q_1\varepsilon} \tag{11}$$

The calculated bubble-slip ratio at the top segments in the absence of gas evolution on the top segments, $S_{b,20}$ is also plotted against I_{1-19} in Fig. 9. From this figure it can be deduced that $S_{b,20}$ increases practically linearly



Fig. 9. r_{20} at $I_{20} = 0$ A, $\varepsilon_{\infty,20}$, β_{20} and $S_{b,20}$ are plotted against I_{1-19} for a hydrogen and oxygen-evolving cell in 22 wt % NaOH at 323 K and a volumetric rate of liquid flow of 6.0 × 10^{-6} m³ s⁻¹.

with increasing β_{20} and increases exponentially with increasing void fraction.

Consequently,

$$S_{\mathrm{b},h} = b_{\mathrm{s}} + a_{\mathrm{s}}\beta_{h} \tag{12}$$

where b_s is the intersection on the S_b axis and a_s is the slope of the $S_{b,20}/\beta_{20}$ straight line. The factors a_s and b_s depend on $v_{1,0}$.

Assuming the current distribution over the cathode is the same as that over the anode, the volumetric rate of the gas flow at a height h in the cell is given by

$$Q_{g,h} = \frac{\int_{0}^{h} V_{m} i w_{e} dh}{(n_{a} + n_{c})F}$$
(13)

where $V_{\rm m}$ is the volume of 1 mol gas saturated with water vapour, $n_{\rm a}$ is the number of electrons involved in the anodic reaction, and $n_{\rm c}$ is the number of electrons involved in the cathodic reaction.

The voidage in the bulk of solution at a height *h* in the cell, $\varepsilon_{\infty,h}$, can be obtained from Equations 11, 12 and 13.

5.3. Effect of the bulk of solution voidage on the voidage at the gas-evolving electrode

Figure 2 shows that r_{20}/I_{1-19} curves at various I_{20} are practically parallel to one another or converge slightly. Using the Bruggeman relation it can be shown that r_{20} at $I_{20} = 0$ A is $(1 - \varepsilon_{\infty,20})^{-1.5}$ where $\varepsilon_{\infty,20}$ is the voidage in the bulk solution at $I_{20} = 0$ A and at the level of segment pair 20. It can be shown that r_{20} corresponds to $r_{s,20}$ and r_{20} at $I_{20} = 0$ A to $r_{s,\infty,20}$.

From numerical calculations it follows that the shape of the $r_s/r_{s,\infty}$ against ε_{∞} curve depends strongly on n_1 , $\varepsilon_{0,0}$ and δ_0 . Only for $n_1 = 1$ the curves at every $\varepsilon_{0,0}$ and δ_0 diverge. Comparing the experimental r_{20}/I_{1-19} curves with the theoretical r_s/ε_{∞} curves it follows that $n_1 > 1$.



Fig. 10. $\epsilon_{0,0}$ and δ_0 are plotted as a function of current density on a double logarithmic scale for a hydrogen and oxygen-evolving cell in 22 wt % NaOH at 323 K and a velocity of liquid flow of $1.88 \times 10^{-2} \, m \, s^{-1}$.

To determine n_1 , experimental data from Fig. 4 are used, *viz*.

- $-r_{s,0} = 1 + 0.515 \times 10^{-4} i$, where *i* is given in A m⁻² and $r_{s,0} = r_{20}$ at $I_{1-19} = 0$ A,
- $-r_{s,20}$ at various I_{1-19} and $I_{20} = 0$ A where $r_{s,20} = r_{20}$ at $I_{20} = 0$ A obtained by extrapolation,
- $-r_{s,20}$ at various I_{20} and I_{1-19} where $r_{s,20}$ is more than about 2% higher than $r_{s,20}$ at $I_{20} = 0$ A. This limitation has been chosen to eliminate the most inaccurate results.

It was found that for $n_1 < 2.5$, the calculated $\varepsilon_{0,0}$ increases up to a fixed I_{20} and thereafter decreases with increasing I_{20} . This result contradicts the generally accepted experimental result, *viz.* $\varepsilon_{0,0}$ increases continuously with increasing current density [3, 5, 12]. Moreover, for $n_1 < 2.5$ the calculated $\varepsilon_{0,0}$ decreases with increasing I_{1-19} or $\varepsilon_{\infty,h}$. This is also an unrealistic result. Consequently, n_1 has to be higher than 2.5.

It was found that the best fit for the experimental results given in Fig. 4 was obtained for $n_1 = 4$. Consequently, the effect of the voidage in the bulk of solution on that within the bubble layer with a thickness δ_0 at the electrode surface is given by

$$\varepsilon_{x,h}^4 = \varepsilon_{0,0}^4 \left(1 - \frac{x}{\delta_0}\right)^4 + \varepsilon_{\infty,h}^4 \qquad (14)$$

From Equation 14 it follows that the voidage profile in the layer with thickness δ_0 changes with increasing $\varepsilon_{\infty,h}$. Since $\varepsilon_{\infty,h}$ increases with increasing height *h* the voidage profile in the layer with thickness δ_0 also changes with increasing height.

The calculated values of $\varepsilon_{0,0}$ and δ_0 are plotted in Fig. 10 as a function of current density, *i*, for the experiments of Fig. 4.

The calculated results for $\varepsilon_{0,0}$ as well as for δ_0 agree reasonably with the experimental results [3, 4], where it has to be taken into account that to calculate $\varepsilon_{0,0}$ and δ_0 the oxygen- and hydrogen-evolving cell is considered as two identical gas-evolving half-cells.

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